

BGE787B

750 MHz, 29 dB gain push-pull amplifier Rev. 4 — 16 September 2011

Product data sheet

1. **Product profile**

1.1 General description

Hybrid high dynamic range amplifier module operating at a supply voltage of 24 V (DC) in a SOT115J package. The module consists of two cascaded stages both in cascode configuration.

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features and benefits

- Excellent linearity
- Extremely low noise
- High gain
- Excellent return loss properties

1.3 Applications

■ Single module line extender in CATV systems operating in the 40 MHz to 750 MHz frequency range.

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	f = 50 MHz	28.5	-	29.5	dB
		f = 750 MHz	29	-	-	dB
I _{tot}	total current consumption (DC)	$V_B = 24 V$	[1] -	-	340	mA

[1] The module normally operates at $V_B = 24 \text{ V}$, but is able to withstand supply transients up to 30 V.



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2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Symbol			
1	input					
2	common	1 3 5 7 9	5			
3	common		$\frac{1}{2}$			
5	+V _B					
7	common		2 3 7 8 sym095			
8	common		,			
9	output					

3. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
BGE787B	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads	SOT115J			

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{B}	supply voltage		-	25	V
Vi	RF input voltage		-	55	dBmV
T _{stg}	storage temperature		-40	+100	°C
T_{mb}	mounting base temperature		-20	+100	°C

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5. Characteristics

Table 5. Characteristics

Bandwidth 40 MHz to 750 MHz; $V_B = 24$ V; $T_{case} = 30$ °C; $Z_S = Z_L = 75$ Ω ; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Gp	power gain	f = 50 MHz		28.5	-	29.5	dB
		f = 750 MHz		29	-	-	dB
SL	slope cable equivalent	f = 40 MHz to 750 MHz		0.2	-	2.2	dB
FL	flatness of frequency response	f = 40 MHz to 750 MHz		-	-	±0.45	dB
S ₁₁	input return losses	f = 40 MHz to 80 MHz		20	-	-	dB
		f = 80 MHz to 160 MHz		18.5	-	-	dB
		f = 160 MHz to 320 MHz		17	-	-	dB
		f = 320 MHz to 640 MHz		15.5	-	-	dB
		f = 640 MHz to 750 MHz		14	-	-	dB
S ₂₂	output return losses	f = 40 MHz to 80 MHz		20	-	-	dB
		f = 80 MHz to 160 MHz		18.5	-	-	dB
		f = 160 MHz to 320 MHz		17	-	-	dB
		f = 320 MHz to 640 MHz		15.5	-	-	dB
		f = 640 MHz to 750 MHz		14	-	-	dB
Ψs21	phase response	f = 50 MHz		135	-	225	deg
СТВ	composite triple beat	110 channels flat; $V_0 = 44 \text{ dBmV}$; measured at 745.25 MHz		-	-	-48	dB
X_{mod}	cross modulation	110 channels flat; V _o = 44 dBmV; measured at 55.25 MHz		-	-	-52	dB
CSO	composite second order distortion	110 channels flat; V _o = 44 dBmV; measured at 746.5 MHz		-	-	-56	dB
d ₂	second order distortion		[1]	-	-	-70	dB
Vo	output voltage	$d_{im} = -60 \text{ dB}$	[2]	59	-	-	dBmV
NF	noise figure	f = 50 MHz		-	-	5	dB
		f = 750 MHz		-	-	6.5	dB
PM	positive match	f = 40 MHz to 2 GHz		-	-	3	dB
I _{tot}	total current consumption (DC)		[3]	-	-	340	mA

 $^{[1] \}quad f_p = 55.25 \text{ MHz}; \ V_p = 44 \text{ dBmV}; \ f_q = 691.25 \text{ MHz}; \ V_q = 44 \text{ dBmV}; \ measured \ at \ f_p + f_q = 746.5 \text{ MHz}.$

^[2] Measured according to DIN45004B; $f_p = 740.25 \text{ MHz}; \ V_p = V_o; \ f_q = 747.25 \text{ MHz}; \ V_q = V_o - 6 \text{ dB}; \ f_r = 749.25 \text{ MHz}; \ V_r = V_o - 6 \text{ dB}; \ measured at \ f_p + f_q - f_r = 738.25 \text{ MHz}.$

^[3] The module normally operates at $V_B = 24 \text{ V}$, but is able to withstand supply transients up to 30 V.

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6. Package outline

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J

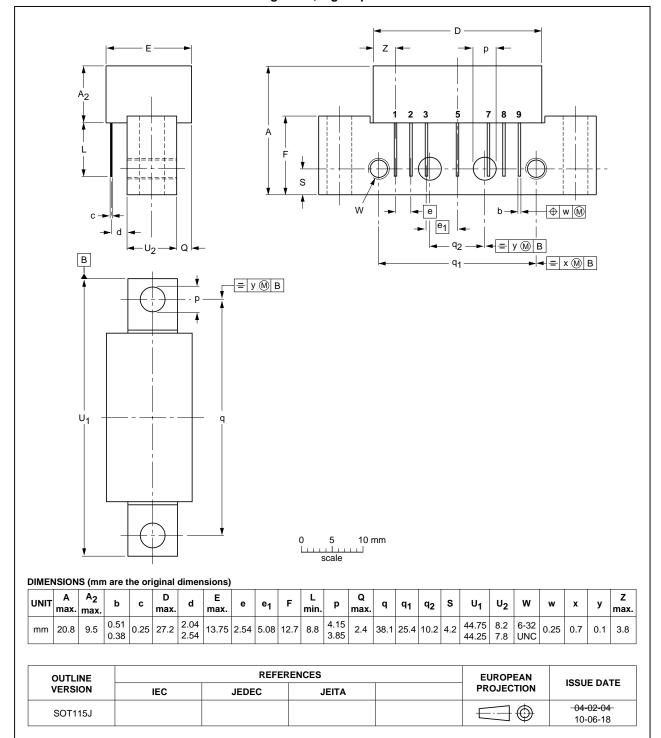


Fig 1. Package outline SOT115J

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7. Revision history

Table 6. Revision history

Release date	Data sheet status	Change notice	Supersedes
20110916	Product data sheet	-	BGE787B v.3
		esigned to comply w	ith the new identity
 Legal texts h 	ave been adapted to the new o	company name whe	re appropriate.
 Package outl 	ine drawings have been updat	ed to the latest vers	ion.
20050329	Product data sheet	-	BGE787B_N v.2
20001003	Preliminary specification	-	BGE787B v.1
20000426	Objective specification	-	-
	20110916 • The format of guidelines of the Legal texts here. Package out the 20050329 20001003	 20110916 Product data sheet The format of this data sheet has been redeguidelines of NXP Semiconductors. Legal texts have been adapted to the new of Package outline drawings have been updated 20050329 Product data sheet 20001003 Preliminary specification 	 20110916 Product data sheet - The format of this data sheet has been redesigned to comply w guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where Package outline drawings have been updated to the latest version 20050329 Product data sheet - 20001003 Preliminary specification -

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8. Legal information

8.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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